Material Composition Dec © Copyright 2005. IPC, Bannockle international and Pan-American co	This document of the level parts	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.							
IPC Web Site for Information on I http://www.ipc.org/IPC-175x	IPC Web Site for Information on IPC-1752 Standard Form Type			claration Class * ass 6 - RoHS Yes/I	No, Homogeneous Mater	rials and Mfg Information			
Supplier Information									
Company name*		Unique ID Authority			Response Date*				
ısemi						2025-07-05			
Contact Name		Phone - Contact*			Email - Contact*				
Product-Env-Stewards		NA			Product-Env-Stewards@onsemi.com				
Authorized Representative*		Phone - Representative*			Email - Representative*				
Product-Env-Stewards	Product Enviro Compliance	oduct Enviro Compliance		NA			Product-Env-Stewards@onsemi.com		
Requester Item Number Mfr Item	Number Mfr Item Name		Effective Date	e Version	Manufacturing Site	Weight*	UOM	Unit Type	
AR02340 A0-CP	CSSM00SUK 2MP 1/3 CIS SO		2025-07-05		TWU	82.3612	mg	Each	
Manufacturing Process Information	ļ.					ļ.			
Terminal Plating / Grid Array Material T	Cerminal Base Alloy J-	STD-020 MSL Rating	Peak Pro	cess Body Temper	ature Max Time at Peak	Temperature Numbe	r of Reflow Cyc	cles	
SnAgCu	CU Alloy 4		245	C	30	seconds 3			
Comments									
or more information regarding material composition	please refer to page 3								

RoHS Material Composition Declaration			Declaration Type *	Detail	led				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU									
cadmium, hexavalentchromium, polybromir contains a RoHS restricted substance inexce encompass all such components. Supplier ce as of the date that Supplier completes this fo Company acknowledges that Supplier may l independently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated dipless of an applicable quantity limit, please intifies that it gathered the information it prome. Supplier acknowledges that Company have relied on information provided by other by others, Supplier agrees that, at a mining and the Supplier enter into a written agree esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substational substance below which, if any, RoHS exemption by desired in this form using appropriate method will rely on this certification in determining ters in completing this form, and that Supplies have provided certification between the will respect to the identified part, the Company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects the company is the company that the company tha	ws of the European Union member states) of the pnce") in excess of the applicable quantity limit iden you believe may apply. If the part is an assemble is to ensure its accuracy and that such information the compliance of its products with European Union may not have independently verified such informs regarding their contributions to the part, and tho terms and conditions of that agreement, including the provides in this formation information the Supplier provides in this formation.	entified above. If a y with lower level is true and correct on member state la nation. However, in se certifications are any warranty rigl	n homogeneous material within the part components, the declaration shall t to the best of its knowledge and belief, aws that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the this and/or remedies provided as part of				
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	ceptance *	Accepted				
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the				
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the				

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	19.54	mg	Supplier	Silicon (Si)	7440-21-3		19.54	mg
Glass Attach Epoxy	0.0012	mg	Supplier	Imidazole	288-32-4		0.0003	mg
			Supplier	Epoxy Phenol Novolak Resin	28064-14-4		0.0009	mg
Glass Lid /Cap	54.35	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		54.35	mg
Insulating Layer	5.51	mg	Supplier	9-Phenylacridine	602-56-2		0.2755	mg
			Supplier	2-Propenoic acid	1245638-61-2		1.653	mg
			Supplier	Other Additive Agents	Proprietary Data		3.306	mg
			Supplier	Butylglycol Acetate	112-07-2		0.2755	mg
Passivation	1.22	mg		Epoxy resin	proprietary data		0.0183	mg
			Supplier	Coupling Agent	Proprietary Data		0.0244	mg
			Supplier	Modified SBR Rubber	Proprietary Data		0.0061	mg
			Supplier	Melamine Compound	Proprietary Data		0.0366	mg
			Supplier	Trispenol Compound	Proprietary Data		0.0366	mg
			Supplier	Photosensitizer	Proprietary Data		0.0976	mg
			Supplier	Hydroxystyrene Resin	Proprietary Data		0.2684	mg
			Supplier	Ethyl Lactate	97-64-3		0.732	mg
RDL	0.82	mg	В	Nickel (Ni)	7440-02-0		0.492	mg
			Supplier	Gold (Au)	7440-57-5		0.0082	mg
			Supplier	Copper (Cu)	7440-50-8		0.3198	mg
Solder Ball	0.92	mg	Supplier	Silver (Ag)	7440-22-4		0.0611	mg
			Supplier	Tin (Sn)	7440-31-5		0.8181	mg
			Supplier	Copper (Cu)	7440-50-8		0.0408	mg